# 4V Drive Pch MOSFET RSU002P03

### ●Structure

Silicon P-channel MOSFET

### ● Features

- 1) Low On-resistance
- 2) 4V drive

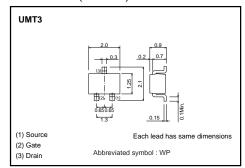
### Applications

Switching

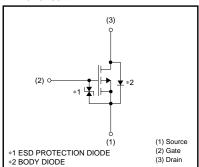
### Packaging specifications

	Package	Taping
Type	Code	T106
	Basic ordering unit (pieces)	3000
RSU002P03	0	

# ● Dimensions (Unit: mm)



### •Inner circuit



## ● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V <sub>DSS</sub>	-30	V
Gate-source voltage		Vgss	±20	V
Drain current	Continuous	ΙD	±0.25	Α
	Pulsed	IDP *1	±0.5	Α
Total power dissipation		P <sub>D</sub> *2	0.2	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1%

## ●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	625	°C/W
* Each terminal mounted on a recommended land			

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<sup>\*2</sup> Each terminal mounted on a recommended land

# ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	-	-	±10	μΑ	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR)</sub> DSS	-30	-	_	V	I <sub>D</sub> = -1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	-1	μΑ	V <sub>DS</sub> = -30V, V <sub>GS</sub> =0V
Gate threshold voltage	VGS (th)	-1.0	-	-2.5	٧	Vps= -10V, Ip= -1mA
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	-	0.9	1.4	Ω	I <sub>D</sub> = -0.25A, V <sub>G</sub> s= -10V
		_	1.4	2.1	Ω	I <sub>D</sub> = -0.15A, V <sub>G</sub> s= -4.5V
		_	1.6	2.4	Ω	ID= -0.15A, VGS= -4V
Forward transfer admittance	Y <sub>fs</sub> *	0.2	-	_	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.15A
Input capacitance	Ciss	-	30	-	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	-	4	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	-	5	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	8	_	ns	Vpp≒ –15V
Rise time	tr *	-	5	-	ns	ID= -0.15A
Turn-off delay time	td (off) *	-	30	-	ns	V <sub>GS</sub> = -10V R <sub>L</sub> =100Ω
Fall time	t <sub>f</sub> *	-	40	-	ns	R <sub>G</sub> =10Ω

<sup>\*</sup>Pulsed

# ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VsD	_	_	-1.2	V	I <sub>S</sub> = -0.1A, V <sub>GS</sub> =0V

### Electrical characteristics curves

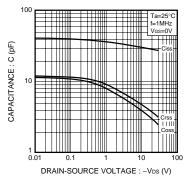


Fig.1 Typical Capacitance vs. Drain-Source Voltage

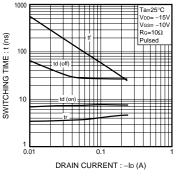


Fig.2 Switching Characteristics

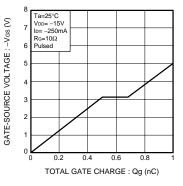


Fig.3 Dynamic Input Characteristics

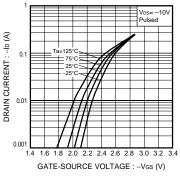


Fig.4 Typical Transfer Characteristics

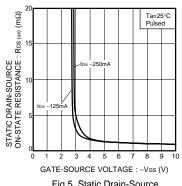


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

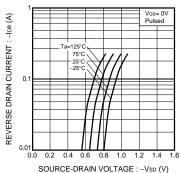


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

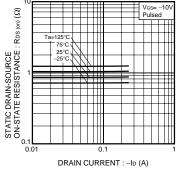
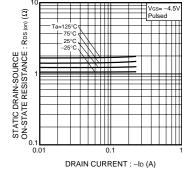
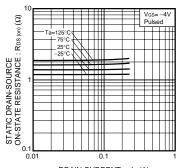


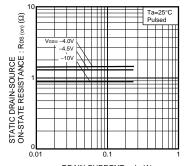
Fig.7 Static Drain-Source On-State Resistance vs. Drain current ( I )



DRAIN CURRENT : -Ib (A)
Fig.8 Static Drain-Source
On-State Resistance vs.
Drain current ( II )



DRAIN CURRENT : -ID (A)
Fig.9 Static Drain-Source
On-State Resistance vs.
Drain current ( III )



DRAIN CURRENT : -lb (A)
Fig.10 Static Drain-Source
On-State Resistance vs.
Drain current ( IV )

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